Multilayer Ceramic Chip Capacitors

1 of 3 Creation Date : May 03, 2025 (GMT)

C5750X7R2E105K230KA



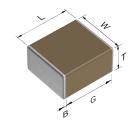






TDK item description C5750X7R2E105KT****

Applications	Commercial Grade Please refer to Part No. CGA9N3X7R2E105K230KA for Automotive use.	
Feature	Mid Voltage (100 to 630V)	
Series	C5750 [EIA 2220]	
Status	Production	
Brand	TDK	



	Size
Length(L)	5.70mm ±0.40mm
Width(W)	5.00mm ±0.40mm
Thickness(T)	2.30mm ±0.20mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	
Recommended Land Pattern (PA)	4.10mm to 4.80mm
Recommended Land Pattern (PB)	1.20mm to 1.40mm
Recommended Land Pattern (PC)	4.00mm to 5.00mm

Electrical Characteristics		
Capacitance	1μF ±10%	
Rated Voltage	250VDC	
Temperature Characteristic	X7R(±15%)	
Dissipation Factor (Max.)	3%	
Insulation Resistance (Min.)	500ΜΩ	

	Other
Operating Temp. Range	-55 to 125°C
Soldering Method	Reflow
AEC-Q200	NO
Packing	Embossed (Plastic)Taping [180mm Reel]
Package Quantity	500pcs

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website. ! All specifications are subject to change without notice.

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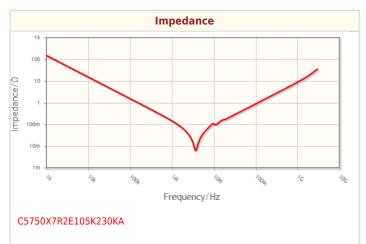




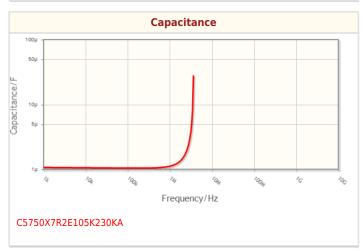


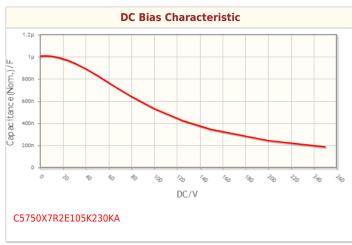


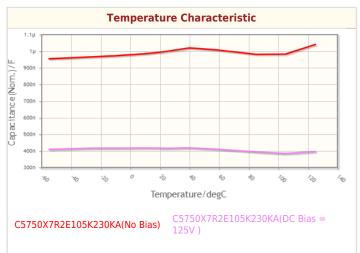
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

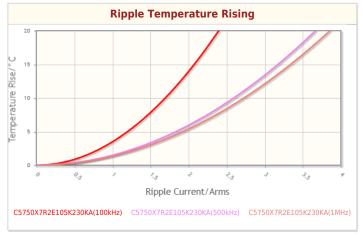












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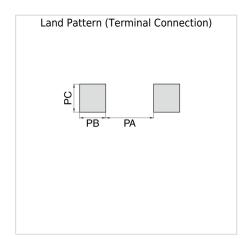






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Associated Images



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